



DOCKET NO.: A0312.70491US00

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Alan W. Righter  
Serial No.: 10/694,675  
Confirmation No.: 4241  
Filed: October 28, 2003  
For: INTEGRATED CIRCUIT BOND PAD STRUCTURES  
AND METHODS OF MAKING

Examiner: Nguyen, Cuong Quang  
Art Unit: 2811

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**CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)**

The undersigned hereby certifies that this document is being placed in the United States mail with first-class postage attached, addressed to MAIL STOP AMENDMENT, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the 20<sup>th</sup> day of April, 2005.

*Doris A. Champagne*  
Doris A. Champagne

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**MAIL STOP AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

Sir:

In response to the Office Action mailed April 5, 2005, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims that begins on page 2 of this Amendment.

**Remarks** begin on page 8 of this Amendment.